

General Description

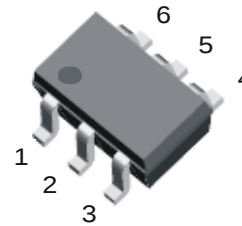
- LMN150B01 is best suited for applications where the load needs to be turned on and off using control circuits like micro-controllers, comparators etc. particularly at a point of load. It features a discrete PNP pass transistor with stable V_{ce_sat} which does not depend on the input voltage and can support maximum continuous current of 150 mA up to 125 °C (see fig. 1). It also contains a discrete NPN that can be used as a control. The component devices can be used as a part of a circuit or as standalone discrete devices.

Features

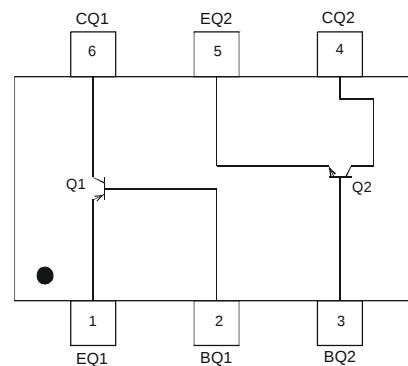
- Epitaxial Planar Die Construction
- Ideally Suited for Automated Assembly Processes
- Lead Free By Design/ROHS Compliant (Note 1)
- "Green" Device (Note 2)

Mechanical Data

- Case: SOT-26
- Case Material: Molded Plastic. "Green Molding" Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminal Connections: See Diagram
- Terminals: Finish - Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 6
- Ordering Information: See Page 6
- Weight: 0.016 grams (approximate)



SOT-26



Schematic and Pin Configuration

Maximum Ratings, Total Device @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Output Current	I_{out}	150	mA

Thermal Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3)	P_D	300	mW
Power Derating Factor above 120 °C	P_{der}	2.33	mW/°C
Thermal Resistance, Junction to Ambient Air (Note 3) (Equivalent to one heated junction of PNP transistor)	$R_{\theta JA}$	417	°C/W
Junction Operation and Storage Temperature Range	T_J, T_{STG}	-55 to +150	°C

- Notes:
- No purposefully added lead.
 - Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
 - Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Page 7.

Maximum Ratings: Discrete PNP Transistor (Q1) @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-40	V
Collector-Emitter Voltage	V _{CEO}	-40	V
Emitter-Base Voltage	V _{EBO}	-6	V
Output Current - continuous (Note 4)	I _C	-200	mA

Maximum Ratings: Discrete NPN Transistor (Q2) @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	60	V
Collector-Emitter Voltage	V _{CEO}	40	V
Emitter-Base Voltage	V _{EBO}	6	V
Output Current - continuous (Note 4)	I _C	200	mA

Electrical Characteristics: Discrete PNP Transistor (Q1) @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 4)					
Collector-Base Breakdown Voltage	V _{CBO}	-40	—	V	I _C = -10uA, I _E = 0
Collector-Emitter Breakdown Voltage	V _{CEO}	-40	—	V	I _C = -1.0mA, I _B = 0
Emitter-Base Breakdown Voltage	V _{EBO}	-6	—	V	I _E = -10μA, I _C = 0
Collector Cutoff Current	I _{CEX}	—	-50	nA	V _{CE} = -30V, V _{EB(OFF)} = -3.0V
Base Cutoff Current	I _{BL}	—	-50	nA	V _{CE} = -30V, V _{EB(OFF)} = -3.0V
Collector-Base Cut Off Current	I _{CBO}	—	-50	nA	V _{CB} = -30V, I _E = 0
Collector-Emitter Cut Off Current	I _{CEO}	—	-50	nA	V _{CE} = -30V, I _B = 0
Emitter-Base Cut Off Current	I _{EBO}	—	-50	nA	V _{EB} = -5V, I _C = 0
ON CHARACTERISTICS (Note 4)					
DC Current Gain	h _{FE}	105	—	—	V _{CE} = -1V, I _C = -100 μA
		110	—	—	V _{CE} = -1V, I _C = -1 mA
		120	—	—	V _{CE} = -1V, I _C = -10 mA
		90	—	—	V _{CE} = -1V, I _C = -50 mA
		32	—	—	V _{CE} = -1V, I _C = -100 mA
		10	—	—	V _{CE} = -1V, I _C = -200 mA
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	—	-0.08	V	I _C = - 10 mA, I _B = -1 mA
		—	-0.15		I _C = -50mA, I _B = -5mA
		—	-0.5		I _C = -200mA, I _B = -20mA
Equivalent on-resistance	R _{CE(SAT)}	—	2.5	Ω	I _C = -200mA, I _B = -20mA
Base-Emitter Turn-on Voltage	V _{BE(ON)}	—	-0.92	V	V _{CE} = -5V, I _C = -200mA
Base-Emitter Saturation Voltage	V _{BE(SAT)}	—	-0.95	V	I _C = -10mA, I _B = -1mA
		—	-1.1		I _C = -50mA, I _B = -5mA
SMALL SIGNAL CHARACTERISTICS					
Output Capacitance	C _{OBO}	—	4	pF	V _{CB} = -5.0 V, f = 1.0 MHz, I _E = 0
Input Capacitance	C _{IBO}	—	8	pF	V _{EB} = -5.0 V, f = 1.0 MHz, I _C = 0
Input Impedance	h _{IE}	2	12	K Ω	V _{CE} = 1.0V, I _c = 10mA, f = 1.0 KHz
Voltage Feedback ratio	h _{RE}	0.1	10	x 10E-4	
Small Signal Current Gain	h _{FE}	100	400	—	
Output Admittance	h _{OE}	3	60	μS	
Current Gain-Bandwidth Product	f _T	250	—	MHz	V _{CE} = - 20V, I _C = -10mA, f = 100 MHz
Noise Figure	NF	—	4	dB	V _{CE} = - 5V, I _c = -100 uA, R _s = 1Ω, f =1 KHz
SWITCHING CHARACTERISTICS					
Delay Time	t _d	—	35	ns	V _{CC} = -3.0 V, I _C = -10 mA,
Rise Time	t _r	—	35	ns	V _{BE(OFF)} = 0.5V, I _{B1} = -1.0 mA
Storage Time	t _s	—	225	ns	V _{CC} = -3.0 V, I _C = -10 mA,
Fall Time	t _f	—	75	ns	I _{B1} = I _{B2} = -1.0 mA

Notes: 4. Short duration pulse test used to minimize self-heating effect.

Electrical Characteristics: Discrete NPN Transistor (Q2) @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 4)					
Collector-Base Breakdown Voltage	V _{CBO}	60	—	V	I _C = 10uA, I _E = 0
Collector-Emitter Breakdown Voltage	V _{CEO}	40	—	V	I _C = 1.0mA, I _B = 0
Emitter-Base Breakdown Voltage	V _{EBO}	6	—	V	I _E = 10μA, I _C = 0
Collector Cutoff Current	I _{CEX}	—	50	nA	V _{CE} = 30V, V _{EB(OFF)} = 3.0V
Base Cutoff Current	I _{BL}	—	50	nA	V _{CE} = 30V, V _{EB(OFF)} = 3.0V
Collector-Base Cut Off Current	I _{CBO}	—	50	nA	V _{CB} = 30V, I _E = 0
Collector-Emitter Cut Off Current	I _{CEO}	—	50	nA	V _{CE} = 30V, I _B = 0
Emitter-Base Cut Off Current	I _{EBO}	—	50	nA	V _{EB} = 5V, I _C = 0
ON CHARACTERISTICS (Note 4)					
DC Current Gain	h _{FE}	150	—	—	V _{CE} = 1V, I _C = 100 μA
		170	—	—	V _{CE} = 1V, I _C = 1 mA
		160	—	—	V _{CE} = 1V, I _C = 10 mA
		70	—	—	V _{CE} = 1V, I _C = 50 mA
		30	—	—	V _{CE} = 1V, I _C = 100 mA
		12	—	—	V _{CE} = 1V, I _C = 200 mA
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	—	0.08	V	I _C = 10 mA, I _B = 1 mA
		—	0.16		I _C = 50mA, I _B = 5mA
		—	0.36		I _C = 200mA, I _B = 20mA
Equivalent on-resistance	R _{CE(SAT)}	—	1.8	Ω	I _C = 200mA, I _B = 20mA
Base-Emitter Turn-on Voltage	V _{BE(ON)}	—	0.98	V	V _{CE} = 5V, I _C = 200mA
Base-Emitter Saturation Voltage	V _{BE(SAT)}	—	0.95	V	I _C = 10mA, I _B = 1mA
		—	1.1		I _C = 50mA, I _B = 5mA
SMALL SIGNAL CHARACTERISTICS					
Output Capacitance	C _{OBO}	—	4	pF	V _{CB} = 5.0 V, f = 1.0 MHz, I _E = 0
Input Capacitance	C _{IBO}	—	8	pF	V _{EB} = 5.0 V, f = 1.0 MHz, I _C = 0
Input Impedance	h _{iE}	2	12	K Ω	V _{CE} = 1.0V, I _C = 10mA, f = 1.0 KHz
Voltage Feedback ratio	h _{rE}	0.1	10	x 10E-4	
Small Signal Current Gain	h _{FE}	100	400	—	
Output Admittance	h _{oE}	3	60	μS	
Current Gain-Bandwidth Product	f _T	250	—	MHz	V _{CE} = 20V, I _C = 0mA, f = 100 MHz
Noise Figure	NF	—	4	dB	V _{CE} = 5V, I _C = 100 uA, R _s = 1Ω, f =1 KHz
SWITCHING CHARACTERISTICS					
Delay Time	t _d	—	35	ns	V _{CC} = -3.0 V, I _C = 10 mA,
Rise Time	t _r	—	35	ns	V _{BE(OFF)} = 0.5V, I _{B1} = 1.0 mA

Typical Characteristics

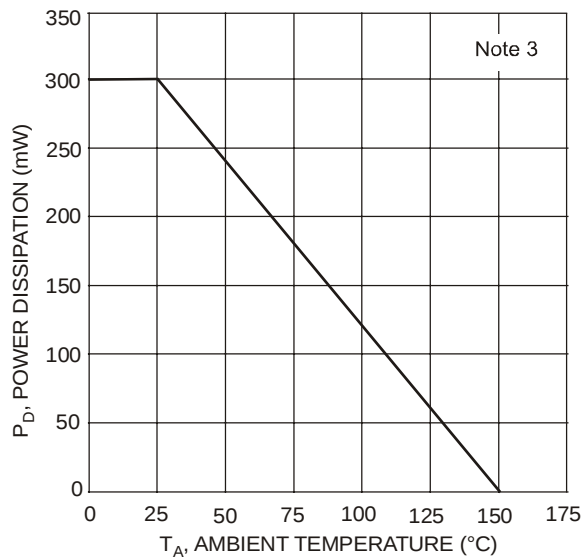


Fig. 1 Max Power Dissipation vs Ambient Temperature

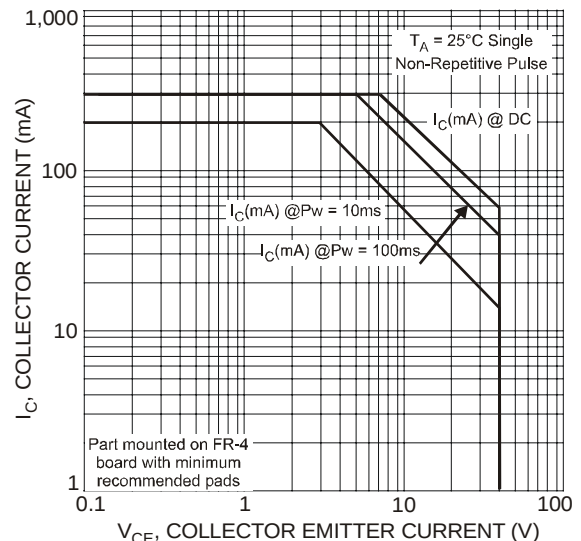


Fig. 2 Safe Operating Area

Characteristics of NPN Transistor (Q2):

NEW PRODUCT

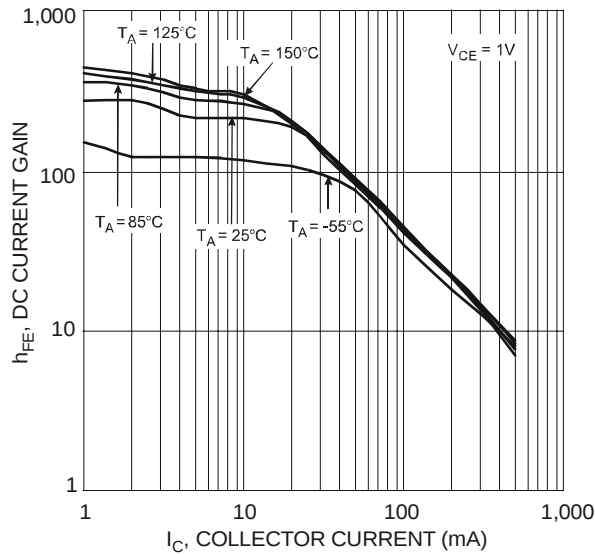


Fig. 3 Typical DC Current Gain vs. Collector Current

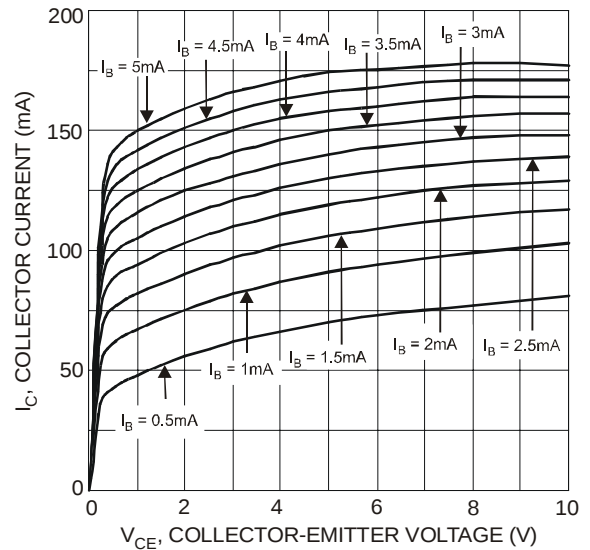


Fig. 4 Collector Current vs. Collector-Emitter Voltage

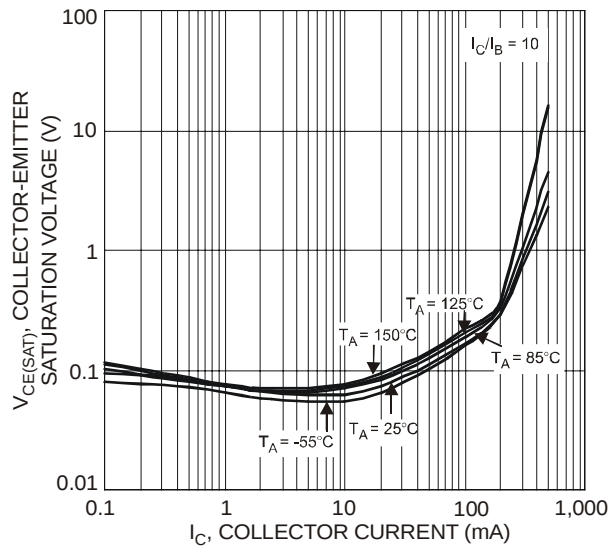


Fig. 5 Collector-Emitter Saturation Voltage vs. Collector Current

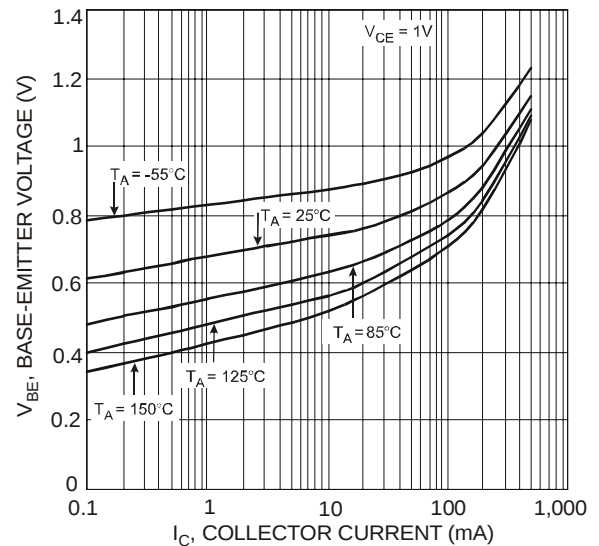


Fig. 6 Base-Emitter Turn-on Voltage vs. Collector Current

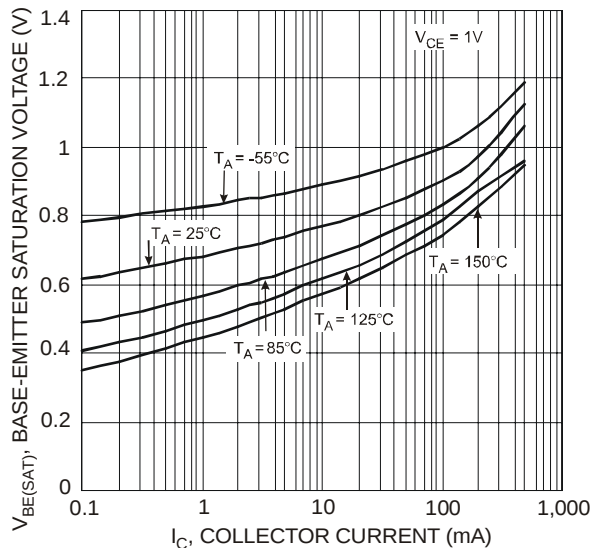


Fig. 7 Base-Emitter Saturation Voltage vs. Collector Current

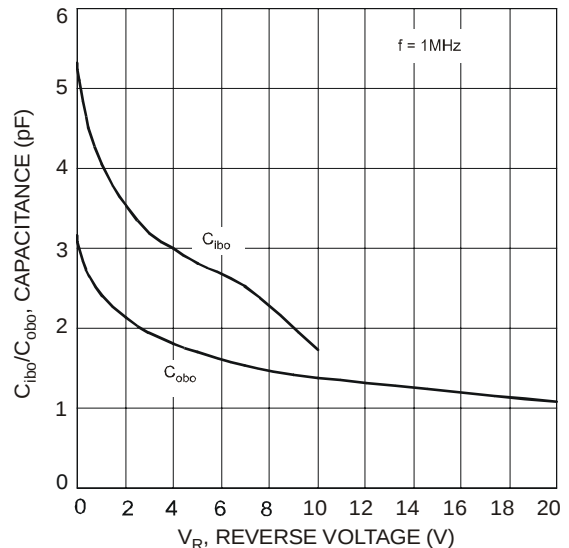


Fig. 8 Typical Capacitance Characteristics

Characteristics of PNP Transistor (Q1):

NEW PRODUCT

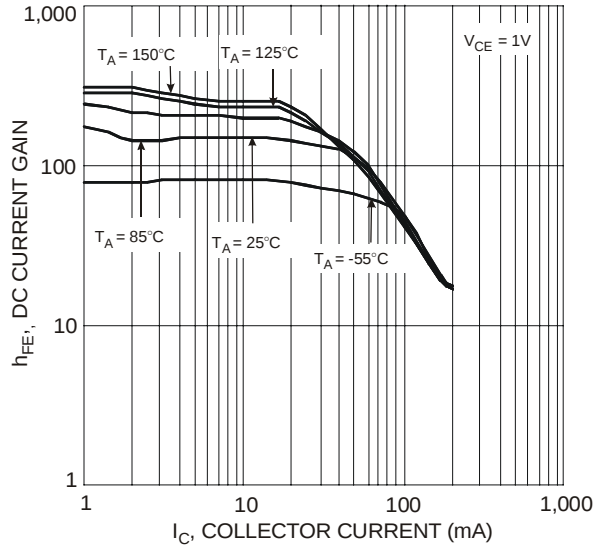


Fig. 9 Typical DC Current Gain vs. Collector Current

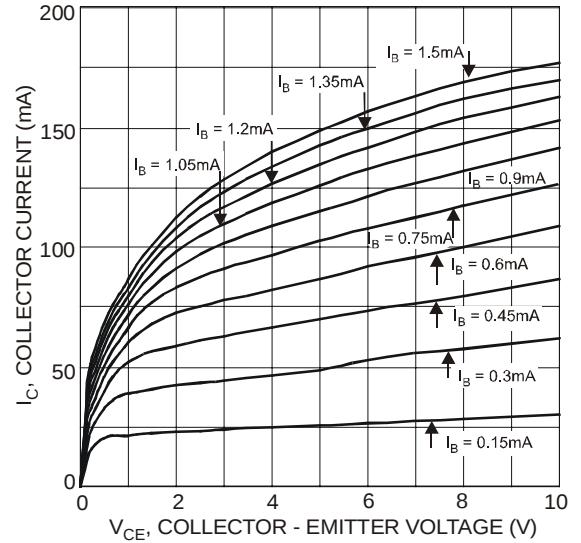


Fig. 10 Collector Current vs. Collector-Emitter Voltage

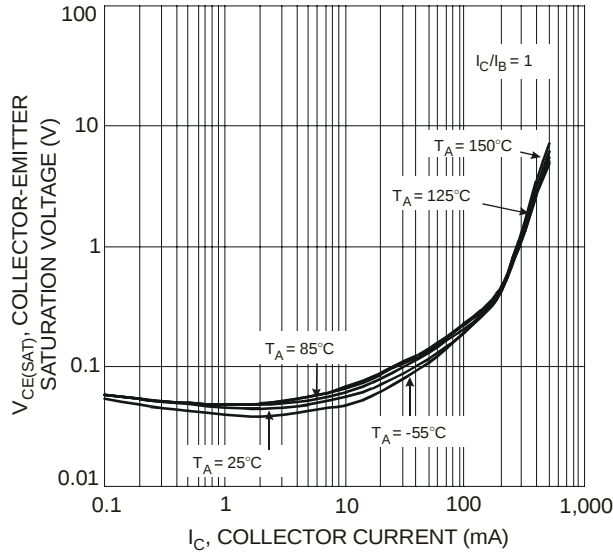


Fig. 11 Collector-Emitter Saturation Voltage vs. Collector Current

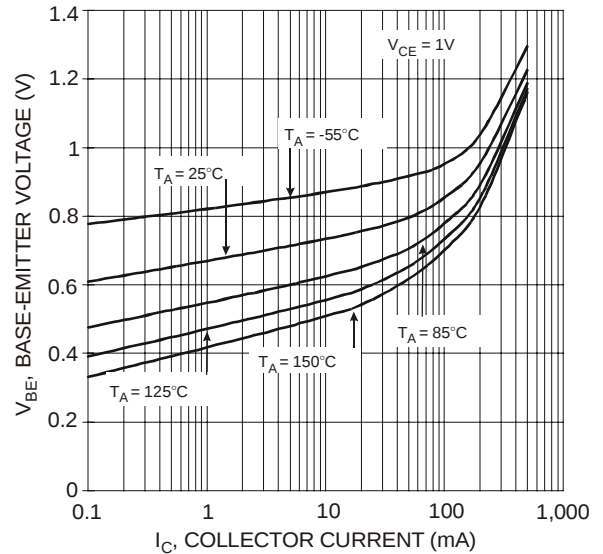


Fig. 12 Base-Emitter Turn-On Voltage vs. Collector Current

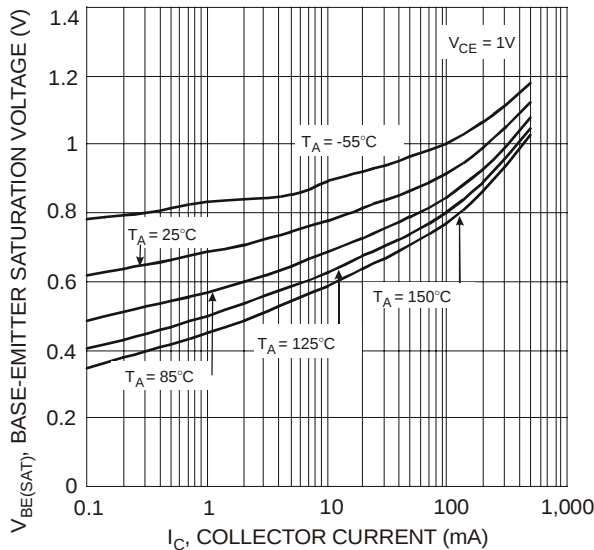


Fig. 13 Base-Emitter Saturation Voltage vs. Collector Current

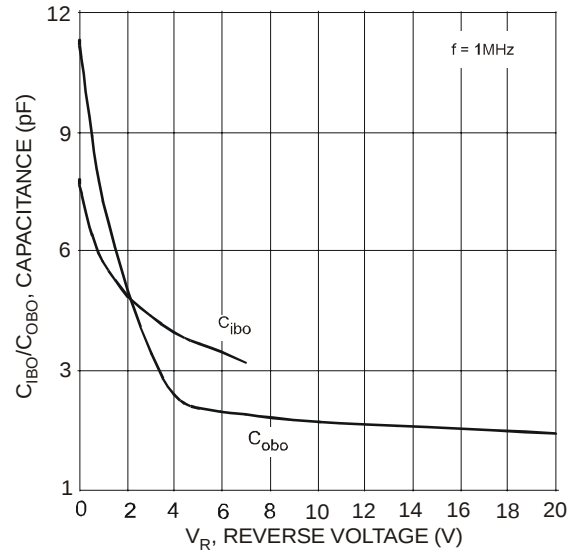
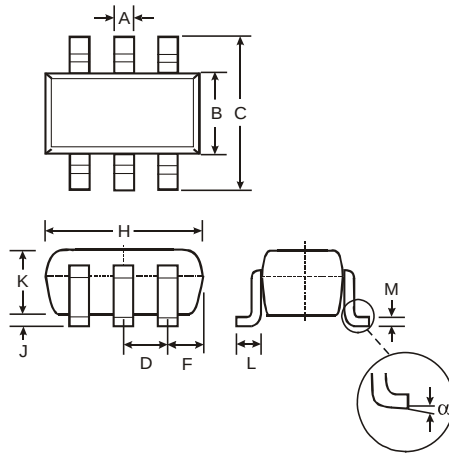


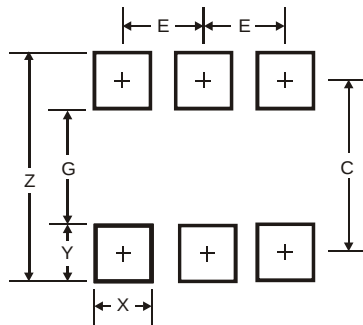
Fig. 14 Typical Capacitance Characteristics

Package Outline Dimensions



SOT-26			
Dim	Min	Max	Typ
A	0.35	0.50	0.38
B	1.50	1.70	1.60
C	2.70	3.00	2.80
D	—	—	0.95
F	—	—	0.55
H	2.90	3.10	3.00
J	0.013	0.10	0.05
K	1.00	1.30	1.10
L	0.35	0.55	0.40
M	0.10	0.20	0.15
α	0°	8°	—
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
Z	3.20
G	1.60
X	0.55
Y	0.80
C	2.40
E	0.95

IMPORTANT NOTICE

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. Diodes Incorporated does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on our website, harmless against all damages.

LIFE SUPPORT

Diodes Incorporated products are not authorized for use as critical components in life support devices or systems without the expressed written approval of the President of Diodes Incorporated.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Diodes Incorporated:](#)

[LBN150B01-7](#)